

**0.5A SURFACE MOUNT SCHOTTKY BARRIER RECTIFIER**
**Features**

- Low Forward Voltage Drop
- Guard Ring Construction for Transient Protection
- High Conductance
- **Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 3 and 4)**
- **Qualified to AEC-Q101 Standards for High Reliability**

**Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Polarity: Cathode Band
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe). Solderable per MIL-STD-202, Method 208
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)



Top View

**Maximum Ratings** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.  
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	$V_{RRM}$	20	V
Working Peak Reverse Voltage	$V_{RWM}$		
DC Blocking Voltage	$V_R$		
RMS Reverse Voltage	$V_{R(RMS)}$	14	V
Average Rectified Output Current @ $T_L = 90^\circ\text{C}$	$I_O$	0.5	A
Non-Repetitive Peak Forward Surge Current 8.3ms single half sine-wave superimposed on rated load	$I_{FSM}$	5.5	A

**Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 1)	$P_D$	410	mW
Typical Thermal Resistance Junction to Ambient (Note 1)	$R_{\theta JA}$	244	$^\circ\text{C}/\text{W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-65 to +125	$^\circ\text{C}$

**Electrical Characteristics** @ $T_A = 25^\circ\text{C}$  unless otherwise specified

Characteristic	Symbol	Value	Unit	Test Conditions
Minimum Reverse Breakdown Voltage (Note 2)	$V_{(BR)R}$	20	V	$I_R = 250\mu\text{A}$
Maximum Forward Voltage Drop	$V_{FM}$	0.300	V	$I_F = 0.1\text{A}, T_J = 25^\circ\text{C}$
		0.385		$I_F = 0.5\text{A}, T_J = 25^\circ\text{C}$
		0.220		$I_F = 0.1\text{A}, T_J = 100^\circ\text{C}$
		0.330		$I_F = 0.5\text{A}, T_J = 100^\circ\text{C}$
Maximum Leakage Current (Note 2)	$I_{RM}$	75	$\mu\text{A}$	$V_R = 10\text{V}, T_J = 25^\circ\text{C}$
		250		$V_R = 20\text{V}, T_J = 25^\circ\text{C}$
	$I_{RM}$	5.0	mA	$V_R = 10\text{V}, T_J = 100^\circ\text{C}$
		8.0		$V_R = 20\text{V}, T_J = 100^\circ\text{C}$
Typical Total Capacitance	$C_T$	170	pF	$V_R = 0\text{V DC}, f = 1\text{MHz}$

- Notes:
1. Device mounted on FR-4 PC board, 2"x2", 2 oz. Copper, single sided. Cathode pad dimensions 0.75"x1.0", Anode pad dimensions 0.25"x1.0".
  2. Pulse Test: Pulse width = 300 $\mu\text{s}$ , Duty Cycle  $\leq 2\%$ .
  3. No purposefully added lead. Halogen and Antimony Free.
  4. Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or  $\text{Sb}_2\text{O}_3$  Fire Retardants.

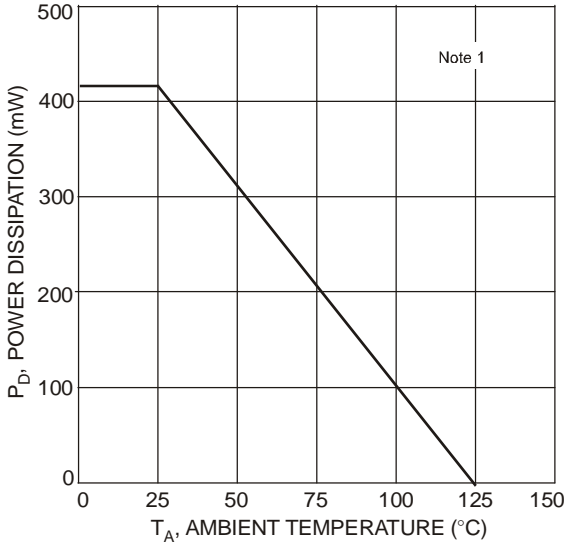


Fig. 1 Forward Power Dissipation

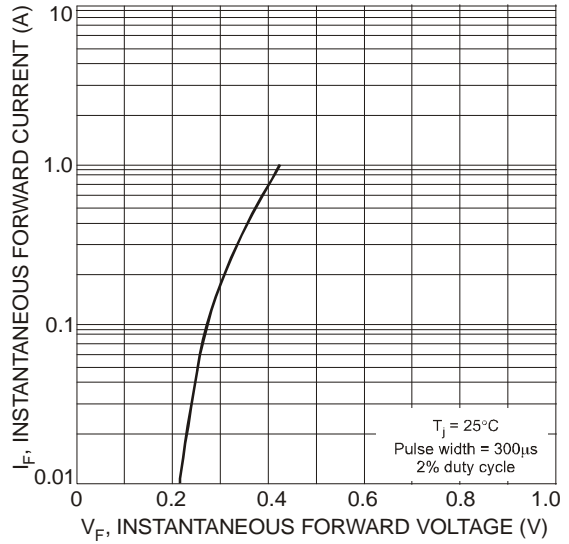


Fig. 2 Typical Forward Characteristics

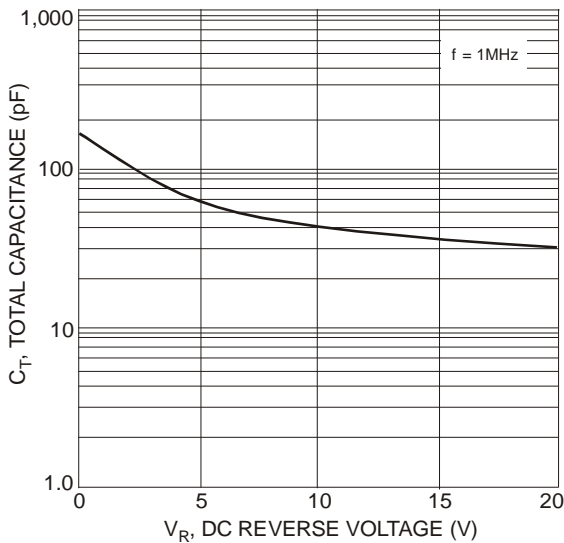


Fig. 3 Total Capacitance vs. Reverse Voltage

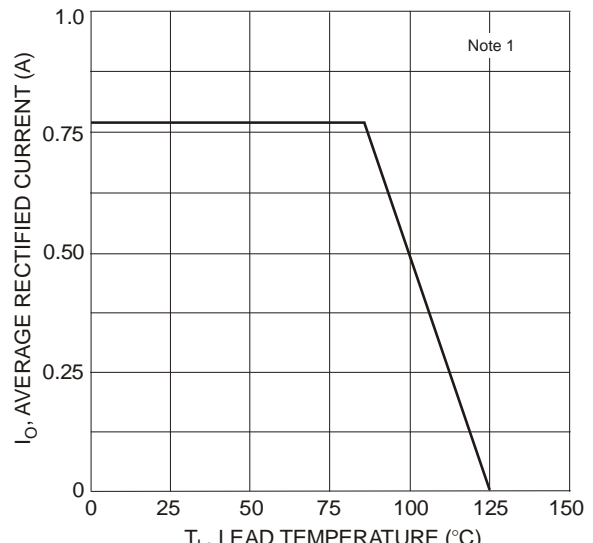


Fig. 4 Forward Current Derating Curve

**Ordering Information** (Note 5)

Part Number	Case	Packaging
B0520LW-7-F	SOD-123	3000/Tape & Reel

Notes: 5. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

**Marking Information**



SD = Product Type Marking Code  
YM = Date Code Marking  
Y = Year (ex: N = 2002)  
M = Month (ex: 9 = September)

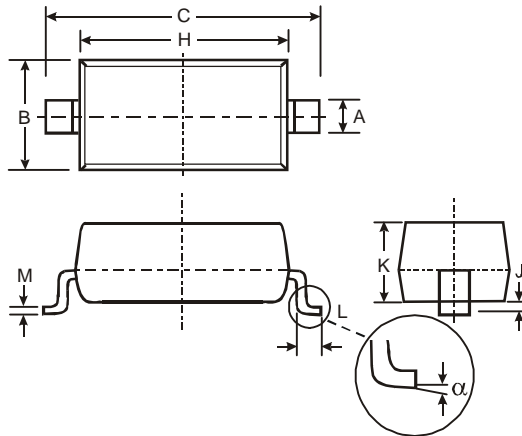
Date Code Key

Year	1998	1999	2000	2001	2002	2003	2004	2005	2006	2007	2008	2009	2010	2011	2012
Code	J	K	L	M	N	P	R	S	T	U	V	W	X	Y	Z

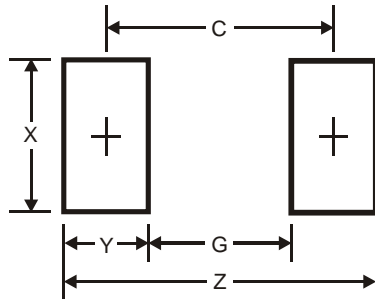
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

**Package Outline Dimensions**



SOD-123		
Dim	Min	Max
A	0.55 Typ	
B	1.40	1.70
C	3.55	3.85
H	2.55	2.85
J	0.00	0.10
K	1.00	1.35
L	0.25	0.40
M	0.10	0.15
$\alpha$	0	8°
All Dimensions in mm		

**Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
X	0.7
Y	1.2
C	3.7

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